

Hyperfast Dual Diode

60 A, 400 V - 600 V

RHRG3060CC, RHRG3040CC

Description

The RHRG3060CC, RHRG3040CC is a hyperfast dual diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction

These devices are intended to be used as freewheeling/ clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Features

- Hyperfast Recovery $t_{rr} = 45 \text{ ns}$ (@ $I_F = 30 \text{ A}$)
- Max Forward Voltage, $V_F = 2.1 \text{ V}$ (@ $T_C = 25^\circ\text{C}$)
- High Reverse Voltage and High Reliability
- Avalanche Energy Rated
- These Devices are Pb-Free and are RoHS Compliant

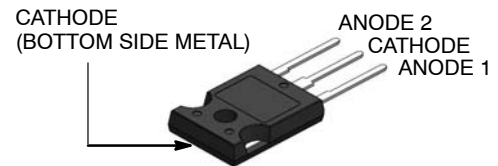
Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

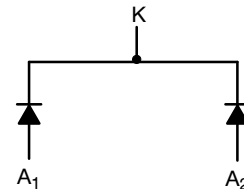


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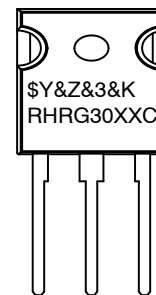
www.onsemi.com



TO-247-3LD
CASE 340CK



MARKING DIAGRAM



| | |
|-----------|-------------------------|
| \$Y | = ON Semiconductor Logo |
| &Z | = Assembly Plant Code |
| &3 | = Numeric Date Code |
| &K | = Lot Code |
| RHRG30XXC | = Specific Device Code |
| XX | = 60, 40 |

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

RHRG3060CC, RHRG3040CC

ABSOLUTE MAXIMUM RATING (Per Leg) ($T_J = 25^\circ\text{C}$, unless otherwise specified)

| Description | Symbol | RHRG3060CC | RHRG3040CC | Unit |
|---|----------------|------------|------------|------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 600 | 400 | V |
| Working Peak Reverse Voltage | V_{RWM} | 600 | 400 | V |
| DC Blocking Voltage | V_R | 600 | 400 | V |
| Average Rectified Forward Current ($T_C = 120^\circ\text{C}$) | $I_{F(AV)}$ | 30 | 30 | A |
| Repetitive Peak Surge Current (Square Wave, 20 kHz) | I_{FRM} | 70 | 70 | A |
| Non-repetitive Peak Surge Current (Halfwave, 1 Phase, 60 Hz) | I_{FSM} | 325 | 325 | A |
| Maximum Power Dissipation | P_D | 125 | 125 | W |
| Avalanche Energy (See Figures 10 and 11) | E_{AVL} | 20 | 20 | mJ |
| Operating and Storage Temperature | T_{STG}, T_J | -65 to 175 | -65 to 175 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Mark | Package | Shipping |
|-------------|-----------|-----------|------------|
| RHRG3060CC | RHRG3060C | TO-247-3L | 450 / Tube |
| RHRG3040CC | RHRG3040C | TO-247-3L | 450 / Tube |

ELECTRICAL SPECIFICATIONS (Per Leg) ($T_J = 25^\circ\text{C}$, unless otherwise specified)

| Characteristic | Symbol | Test Conditions | RHRG3060CC | | | RHRG3040CC | | | Unit |
|---|-----------------|---|------------|-----|-----|------------|-----|-----|---------------------------|
| | | | Min | Typ | Max | Min | Typ | Max | Unit |
| Instantaneous Forward Voltage (Pulse Width = 300 μs , Duty Cycle = 2%) | V_F | $I_F = 30\text{ A}$ | - | - | 2.1 | - | - | 2.1 | V |
| | | $I_F = 30\text{ A}, T_C = 150^\circ\text{C}$ | - | - | 1.7 | - | - | 1.7 | V |
| Instantaneous Reverse Current | I_R | $V_R = 400\text{ V}$ | - | - | - | - | - | 250 | μA |
| | | $V_R = 600\text{ V}$ | - | - | 250 | - | - | - | μA |
| | | $V_R = 400\text{ V}, T_C = 150^\circ\text{C}$ | - | - | - | - | - | 1.0 | mA |
| | | $V_R = 600\text{ V}, T_C = 150^\circ\text{C}$ | - | - | 1.0 | - | - | - | mA |
| Reverse Recovery Time (See Figure 9), Summation of $t_a + t_b$. | T_{rr} | $I_F = 1\text{ A}, dI_F/dt = 200\text{ A}/\mu\text{s}$ | - | - | 40 | - | - | 40 | ns |
| | | $I_F = 30\text{ A}, dI_F/dt = 200\text{ A}/\mu\text{s}$ | - | - | 45 | - | - | 45 | ns |
| Time to Reach Peak Reverse Current (See Figure 9). | t_a | $I_F = 30\text{ A}, dI_F/dt = 200\text{ A}/\mu\text{s}$ | - | 22 | - | - | 22 | - | ns |
| Time from Peak I_{RM} to Projected Zero Crossing of I_{RM} Based on a Straight Line from Peak I_{RM} through 25% of I_{RM} (See Figure 9). | t_b | $I_F = 30\text{ A}, dI_F/dt = 200\text{ A}/\mu\text{s}$ | - | 18 | - | - | 18 | - | ns |
| Reverse Recovery Charge | Q_{rr} | $I_F = 30\text{ A}, dI_F/dt = 200\text{ A}/\mu\text{s}$ | - | 100 | - | - | 100 | - | nC |
| Junction Capacitance | C_J | $V_R = 10\text{ V}, I_F = 0\text{ A}$ | - | 85 | - | - | 85 | - | pF |
| Thermal Resistance Junction to Case | $R_{\theta JC}$ | | - | - | 1.2 | - | - | 1.2 | $^\circ\text{C}/\text{W}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

RHRG3060CC, RHRG3040CC

TYPICAL PERFORMANCE CURVES

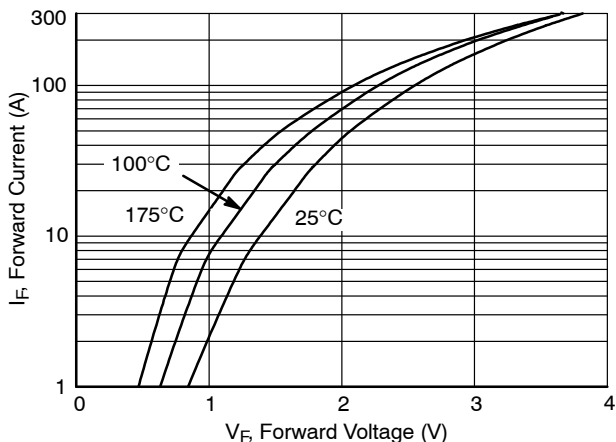


Figure 1. Forward Current vs. Forward Voltage

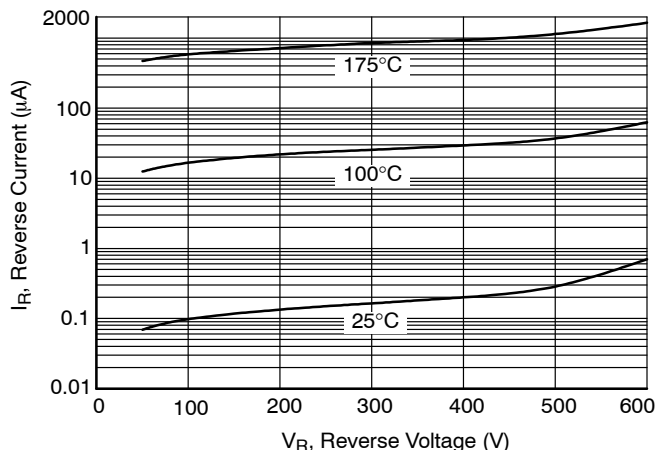


Figure 2. Reverse Current vs. Reverse Voltage

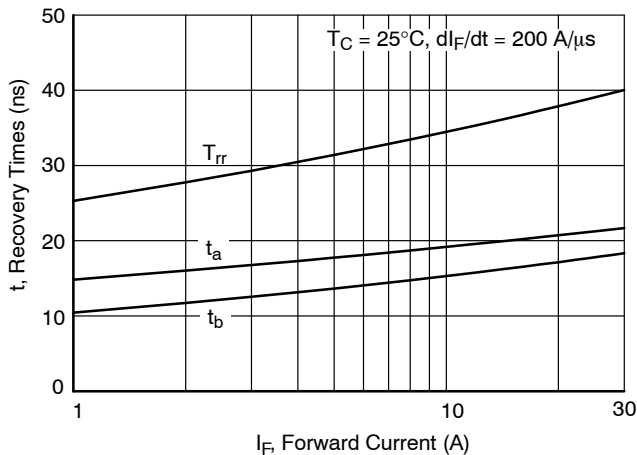


Figure 3. T_{rr} , t_a and t_b Curves vs. Forward Current

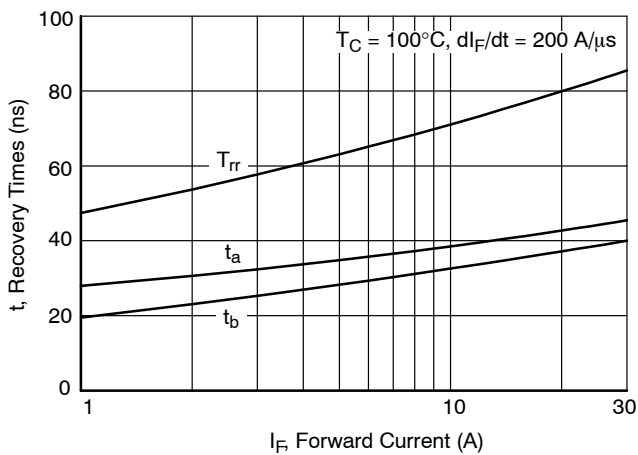


Figure 4. T_{rr} , t_a and t_b Curves vs. Forward Current

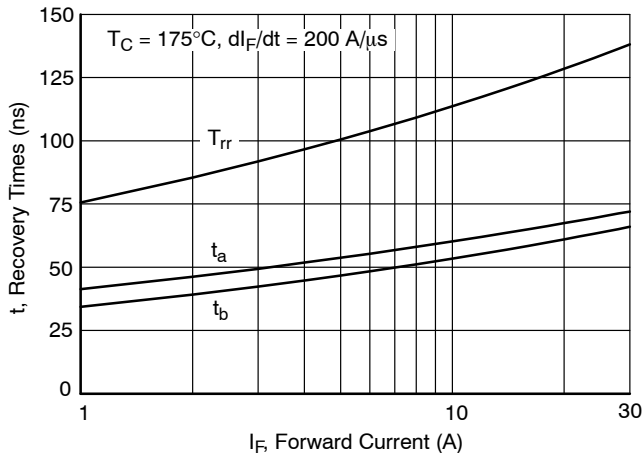


Figure 5. T_{rr} , t_a and t_b Curves vs. Forward Current

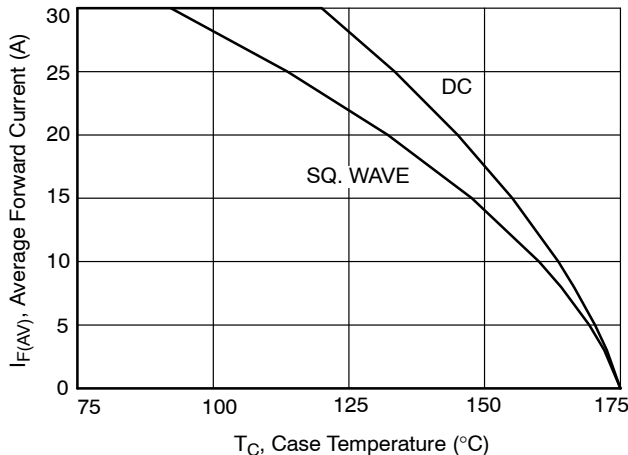


Figure 6. Current Derating Curve

RHRG3060CC, RHRG3040CC

TYPICAL PERFORMANCE CURVES (continued)

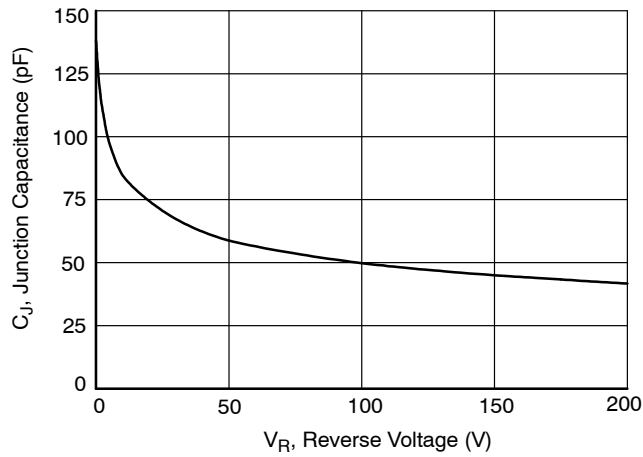


Figure 7. Junction Capacitance vs. Reverse Voltage

TEST CIRCUITS AND WAVEFORMS

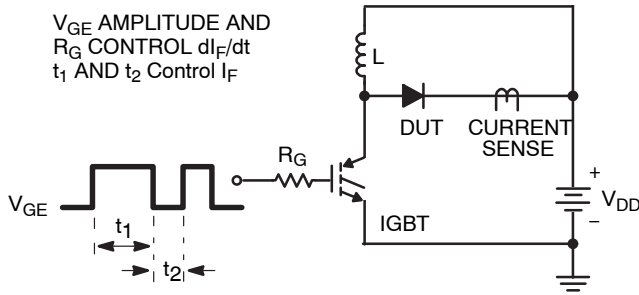


Figure 8. T_{rr} Test Circuit

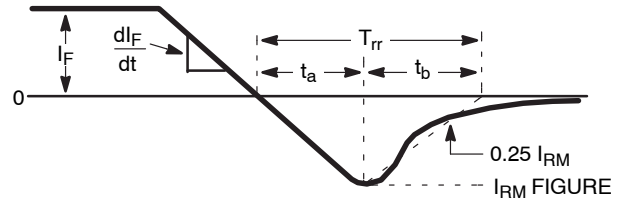


Figure 9. T_{rr} Waveforms and Definitions

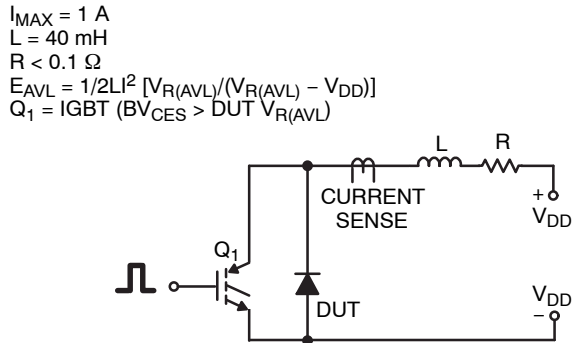


Figure 10. Avalanche Energy Test Circuit

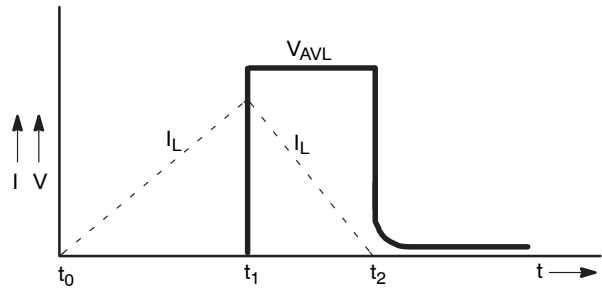
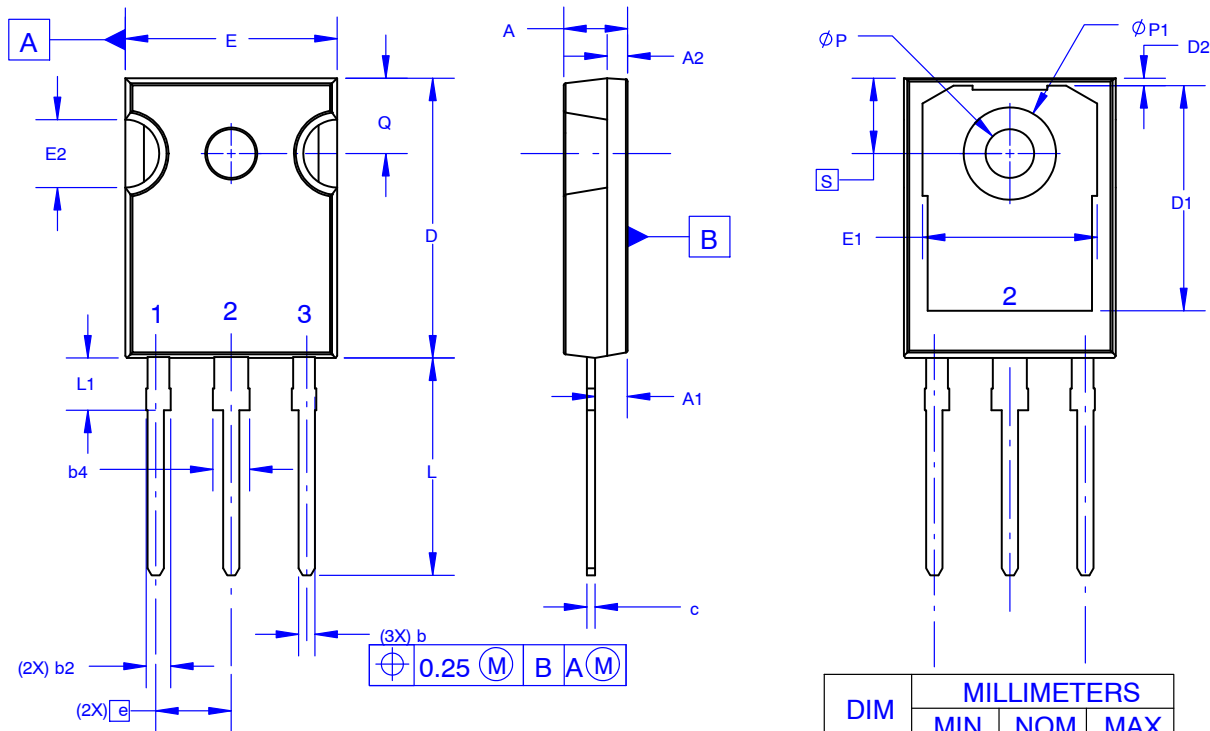


Figure 11. Avalanche Current and Voltage Waveforms

TO-247-3LD SHORT LEAD
CASE 340CK
ISSUE A

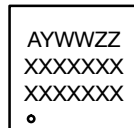
DATE 31 JAN 2019



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



- XXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

| DIM | MILLIMETERS | | |
|-----|-------------|-------|-------|
| | MIN | NOM | MAX |
| A | 4.58 | 4.70 | 4.82 |
| A1 | 2.20 | 2.40 | 2.60 |
| A2 | 1.40 | 1.50 | 1.60 |
| b | 1.17 | 1.26 | 1.35 |
| b2 | 1.53 | 1.65 | 1.77 |
| b4 | 2.42 | 2.54 | 2.66 |
| c | 0.51 | 0.61 | 0.71 |
| D | 20.32 | 20.57 | 20.82 |
| D1 | 13.08 | ~ | ~ |
| D2 | 0.51 | 0.93 | 1.35 |
| E | 15.37 | 15.62 | 15.87 |
| E1 | 12.81 | ~ | ~ |
| E2 | 4.96 | 5.08 | 5.20 |
| e | ~ | 5.56 | ~ |
| L | 15.75 | 16.00 | 16.25 |
| L1 | 3.69 | 3.81 | 3.93 |
| ∅P | 3.51 | 3.58 | 3.65 |
| ∅P1 | 6.60 | 6.80 | 7.00 |
| Q | 5.34 | 5.46 | 5.58 |
| S | 5.34 | 5.46 | 5.58 |

| | | |
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